- EPIC[™] (Enhanced-Performance Implanted CMOS) Process
- Typical V_{OLP} (Output Ground Bounce)
 < 0.8 V at V_{CC}, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 > 2 V at V_{CC}, T_A = 25°C
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Small-Outline (D, NS), Shrink Small-Outline (DB), Thin Very Small-Outline (DGV), and Thin Shrink Small-Outline (PW) Packages, Ceramic Flat (W) Packages, Chip Carriers (FK), and DIPs (J)

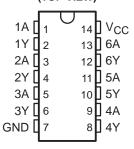
description

These hex Schmitt-trigger inverters are designed for 2-V to 5.5-V V_{CC} operation.

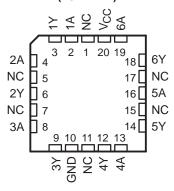
The 'LV14A devices contain six independent inverters. These devices perform the Boolean function $Y = \overline{A}$.

The SN54LV14A is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74LV14A is characterized for operation from -40°C to 85°C.

SN54LV14A . . . J OR W PACKAGE SN74LV14A . . . D, DB, DGV, NS, OR PW PACKAGE (TOP VIEW)



SN54LV14A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

FUNCTION TABLE (each inverter)

INPUT	OUTPUT
Α	Υ
Н	L
L	н

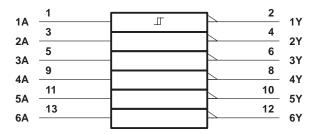


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logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, DB, DGV, J, NS, PW, and W packages.

logic diagram, each inverter (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V _{CC}		–0.5 V to 7 V
Input voltage range, V _I (see Note 1)		
Output voltage range, V _O (see Notes 1 and 2)		–0.5 V to V _{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)		–20 mA
Output clamp current, IOK (VO < 0 or VO > VCO	C)	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	-	±25 mA
Continuous current through V _{CC} or GND		±50 mA
Package thermal impedance, θ_{JA} (see Note 3):	: D package	127°C/W
	DB package	158°C/W
	DGV package	182°C/W
	NS package	127°C/W
	PW package	170°C/W
Storage temperature range, T _{stg}		–65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stressratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. This value is limited to 7 V maximum.
 - 3. The package thermal impedance is calculated in accordance with JESD 51.



recommended operating conditions (see Note 4)

			SN54L	/14A	SN74L	.V14A	UNIT
			MIN	MAX	MIN	MAX	UNII
Vcc	Supply voltage		2	5.5	2	5.5	V
		V _{CC} = 2 V	1.5		1.5		
V	High lovel input veltage	V _{CC} = 2.3 V to 2.7 V	V _{CC} ×0.7		V _{CC} × 0.7		V
VIH	High-level input voltage	V _{CC} = 3 V to 3.6 V	V _{CC} ×0.7		V _{CC} × 0.7		ľ
		V _{CC} = 4.5 V to 5.5 V	V _{CC} ×0.7		V _{CC} × 0.7		
		V _{CC} = 2 V		0.5		0.5	
V	Low level input valtage	V _{CC} = 2.3 V to 2.7 V	\	/CC×0.3		V _{CC} ×0.3	V
V _{IL}		V _{CC} = 3 V to 3.6 V	\	/ _{CC} ×0.3	V _{CC} ×0.3		1 °
		V _{CC} = 4.5 V to 5.5 V	\	/CC×0.3		V _{CC} ×0.3	1
٧ _I	Input voltage		0	5.5	0	5.5	V
٧o	Output voltage		0 2	Vcc	0	Vcc	V
		V _{CC} = 2 V	Z.	-50		-50	μΑ
	High level cutout current	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-2		-2	
ІОН	High-level output current	V _{CC} = 3 V to 3.6 V		-6		-6	mA
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		-12		-12	
		V _{CC} = 2 V		50		50	μΑ
1	Low lovel output ourrent	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2		2	
lOL	Low-level output current	V _{CC} = 3 V to 3.6 V		6		6	mA
		V _{CC} = 4.5 V to 5.5 V		12		12	
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DARAMETER	TEST SOMBITIONS	T ,,	SN54LV14A		SN7	4LV14	Δ.		
PARAMETER	TEST CONDITIONS	VCC	MIN TYP	MAX	MIN	TYP	MAX	UNIT	
V _{T+}		2.5 V		1.75			1.75		
Positive-going		3.3 V		2.31			2.31	V	
threshold		5 V		3.5			3.5		
V _T _		2.5 V	0.75		0.75				
Negative-going		3.3 V	0.99		0.99			V	
threshold		5 V	1.5		1.5				
		2.5 V	0.25	1	0.25		1		
ΔV_T Hysteresis ($V_{T+} - V_{T-}$)		3.3 V	0.33	1.32	0.33		1.32	V	
11yoto10010 (V + V =)		5 V	0.5	2	0.5		2		
	$I_{OH} = -50 \mu\text{A}$	2 V to 5.5 V	V _{CC} -0.1		V _{CC} -0.1				
\/a	$I_{OH} = -2 \text{ mA}$	2.3 V	2		2			V	
VOH	$I_{OH} = -6 \text{ mA}$	3 V	2.48		2.48			V	
	$I_{OH} = -12 \text{ mA}$	4.5 V	3.8		3.8				
	I _{OL} = 50 μA	2 V to 5.5 V	Q	0.1			0.1		
\/a	I _{OL} = 2 mA	2.3 V		0.4			0.4	V	
VOL	I _{OL} = 6 mA	3 V		0.44			0.44	v	
	I _{OL} = 12 mA	4.5 V		0.55			0.55		
lį	$V_I = V_{CC}$ or GND	5.5 V		±1			±1	μΑ	
lcc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V		20			20	μΑ	
l _{off}	V_I or $V_O = 0$ to 5.5 V	0 V		5			5	μΑ	
C _i	3.3 V	3.3 V	2.3			2.3		pF	
U G	$V_I = V_{CC}$ or GND	5 V	2.3			2.3		ÞΓ	

switching characteristics over recommended operating free-air temperature range, V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T _A = 25°C		T _A = 25°C		T _A = 25°C SN54LV14A		T _A = 25°C SN54		SN74LV14A		UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	ΛΑΝ	MIN	MAX	UNIT			
t _{pd} *	А	Υ	C _L = 15 pF		10.2	19.7	9.11	22	1	22	ns			
t _{pd}	А	Υ	C _L = 50 pF		13.3	24	Q1	27	1	27	ns			

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T,	չ = 25°C	;	SN54LV14A	SN74L	.V14A	UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN MAX	MIN	MAX	UNIT
t _{pd} *	А	Υ	C _L = 15 pF		7.3	12.8	9 15.9	1	15	ns
^t pd	А	Υ	C _L = 50 pF		9.6	16.3	1 19.4	1	18.5	ns

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.



switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER		FROM	то	LOAD	T _A = 25°C		SN54LV	14A	SN74L	V14A	UNIT		
FAR	KAMETER	(INPUT)	(OUTPUT) CAPACITAN	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
	t _{pd} *	А	Υ	C _L = 15 pF		5.1	8.6	69,1	10	1	10	ns	
	t _{pd}	А	Υ	C _L = 50 pF		6.7	10.6	Q1	12	1	12	ns	

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

noise characteristics, V_{CC} = 3.3 V, C_L = 50 pF, T_A = 25°C (see Note 5)

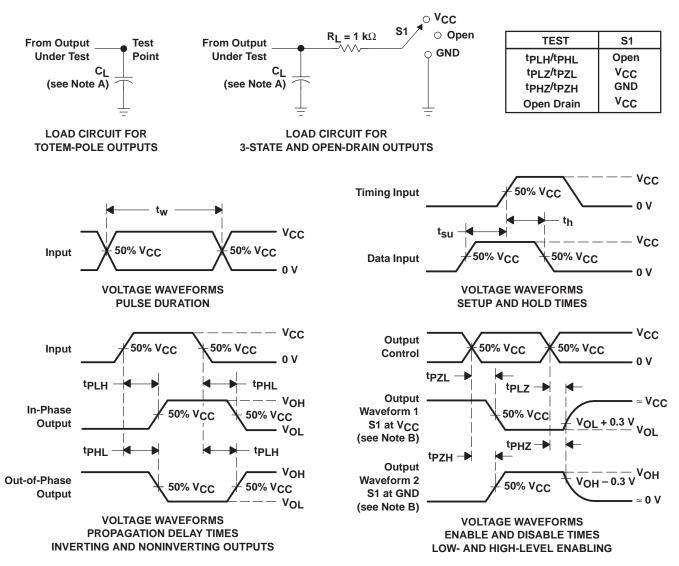
	PARAMETER	SN	UNIT		
	PARAMETER				UNII
V _{OL(P)}	Quiet output, maximum dynamic V _{OL}		0.22	0.8	V
V _{OL(V)}	Quiet output, minimum dynamic V _{OL}		-0.1	-0.8	V
VOH(V)	Quiet output, minimum dynamic VOH		3.1		V
VIH(D)	High-level dynamic input voltage	2.31			V
V _{IL(D)}	Low-level dynamic input voltage			0.99	V

NOTE 5: Characteristics are for surface-mount packages only.

operating characteristics, T_A = 25°C

	PARAMETER			TEST CONDITIONS			UNIT
Γ	C _{pd}	Power dissipation capacitance	$C_1 = 50 pF$	f = 10 MHz	3.3 V	8.8	nЕ
-			CL = 50 pr,	1 = 10 101112	5 V	9.6	- pF

PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_Q = 50 \Omega$, $t_f \leq 3$ ns, $t_f \leq 3$ ns.
 - D. The outputs are measured one at a time with one input transition per measurement.
 - E. tpLz and tpHz are the same as tdis.
 - F. tpzL and tpzH are the same as ten.
 - G. tpHL and tpLH are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



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